

MCT9001 Dual Phototransistor Optocouplers

Features

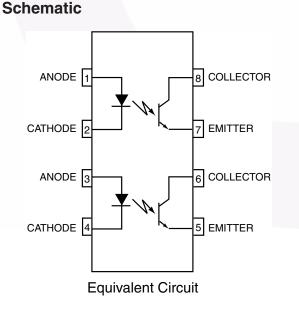
- Two isolated channels per package
- Two packages fit into a 16 lead DIP socket
- Underwriters Laboratory (U.L.) recognized File E90700
- VDE approved for IEC60747-5-2

Applications

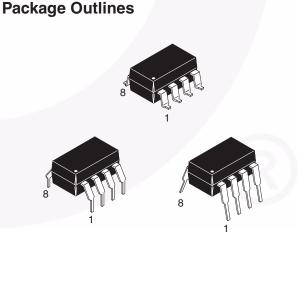
- AC line/digital logic isolate high voltage transients
- Digital logic/digital logic eliminate spurious grounds
- Digital logic/AC triac control isolate high voltage transients
- Twisted pair line receiver eliminate ground loop feedthrough
- Telephone/telegraph line receiver isolate high voltage transients
- High frequency power supply feedback control maintain floating grounds and transients
- Relay contact monitor isolate floating grounds and transients
- Power supply monitor isolate transients

Description

The MCT9001 Optocoupler has two channels for density applications. For four channel applications, two-packages fit into a standard 16-pin DIP socket. Each channel is an NPN silicon planar phototransistor optically coupled to a gallium arsenide infrared emitting diode.







February 2010

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Rating	Value	Unit
TOTAL DEVICE			
T _{STG}	Storage Temperature	-55 to +150	°C
T _{OPR}	Operating Temperature	-55 to +100	°C
T _{SOL}	Lead Solder Temperature (Refer to Reflow Temperature Profile)	260 for 10 sec	°C
PD	Total Device Power Dissipation @ T _A = 25°C	400	mW
	Derate above 25°C	4.83	mW/°C
EMITTER (Each	channel)		
I _F	Forward Current – Continuous	60	mA
I _F (pk)	Forward Current – Peak (PW = 1µs, 300pps)	3	А
V _R	Reverse Voltage	5.0	V
PD	LED Power Dissipation @ T _A = 25°C	100	mW
	Derate above 25°C (Total Input)	1.1	mW/°C
DETECTOR (Ea	ch channel)		
Ι _C	Collector Current – Continuous	30	mA
P _D	Detector Power Dissipation @ $T_A = 25^{\circ}C$	150	mW
	Derate above 25°C	1.67	mW/°C

Electrical Characteristics ($T_A = 25^{\circ}C$ unless otherwise specified)

Individual Component Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.*	Max.	Unit
EMITTER						
V _F	Input Forward Voltage	I _F = 10mA		1.0	1.3	V
I _R	Reverse Current	$V_{R} = 5V$			10	μA
CJ	Junction Capacitance	V _F = 0 V, f = 1MHz		50		pF
DETECTO	R		•			
BV _{CEO}	Collector-Emitter Breakdown Voltage	$I_{\rm C} = 0.5 {\rm mA}, I_{\rm F} = 0$	55			V
BV _{ECO}	Emitter-Collector Breakdown Voltage	$I_{E} = 100 \mu A, I_{F} = 0$	7			V
I _{CEO}	Collector-Emitter Dark Current	$V_{CE} = 24V, I_{F} = 0$		5	100	nA
		$V_{CE} = 24V, T_A = 85^{\circ}C$			50	μA
C _{CE}	Capacitance	$V_{CE} = 0V$, f = 1MHz		8		pF

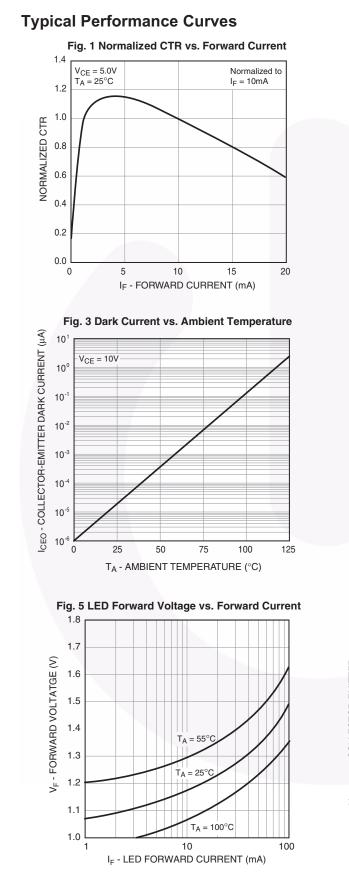
Transfer Characteristics

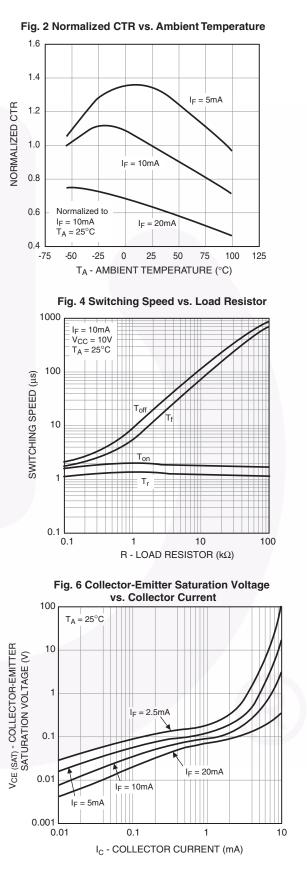
Symbol	Parameter	Test Conditions	Min.	Typ.*	Max.	Units
SWITCHIN	G TIMES (AC)				1	
Non-Satur	ated					
t _{on}	Turn-on Time	$R_L = 100\Omega, I_C = 2mA, V_{CC} = 10V$		3		μs
t _{off}	Turn-off Time			3		μs
t _r	Rise Time			2.4		μs
t _f	Fall Time	_		2.4		μs
Saturated			1			
t _{on}	Turn-on Time	$I_{F} = 16 \text{mA}, R_{L} = 1.9 \text{k}\Omega, V_{CE} = 5 \text{V}$		2.4		μs
t _{off}	Turn-off Time			25.0		μs
DC CHAR	ACTERISTICS		1			
CTR	Current Transfer Ratio,	$I_{F} = 5mA, V_{CE} = 5V$	50		600	%
CTR _(sat)	Collector-Emitter	$I_{F} = 8mA, V_{CE} = 0.4V$	30			%
V _{CE(sat)}	Saturation Voltage	$I_{\rm F} = 8 {\rm mA}, I_{\rm C} = 2.4 {\rm mA}$			0.40	V

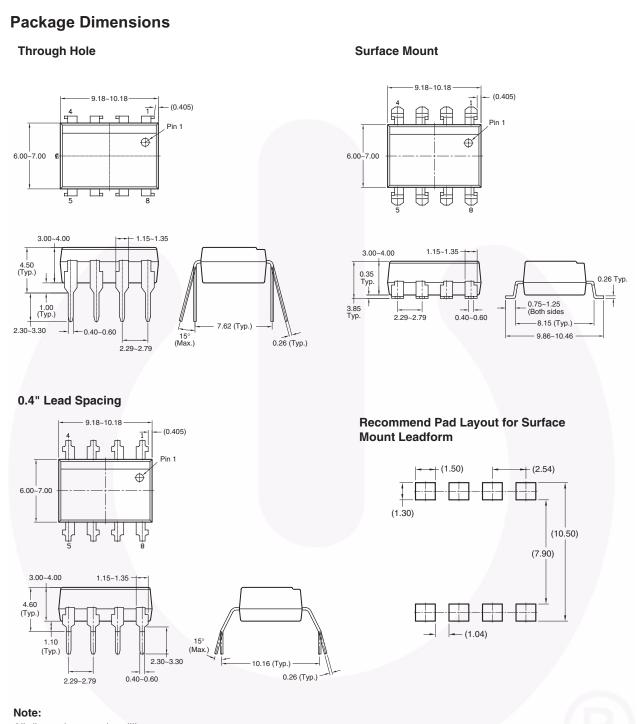
Isolation Characteristics

Symbol	Characteristic	Test Conditions	Min.	Тур.*	Max.	Units
V _{ISO}	Input-Output Isolation Voltage	$I_{I-O} \le 10 \mu A$, t = 1min.	5000			Vac(rms)
R _{ISO}	Isolation Resistance	V _{I-O} = 500VDC	10 ¹¹			Ω
C _{ISO}	Isolation Capacitance	f = 1MHz		0.5		pF

*All typicals at $T_A = 25^{\circ}C$







All dimensions are in millimeters.

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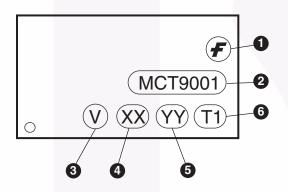
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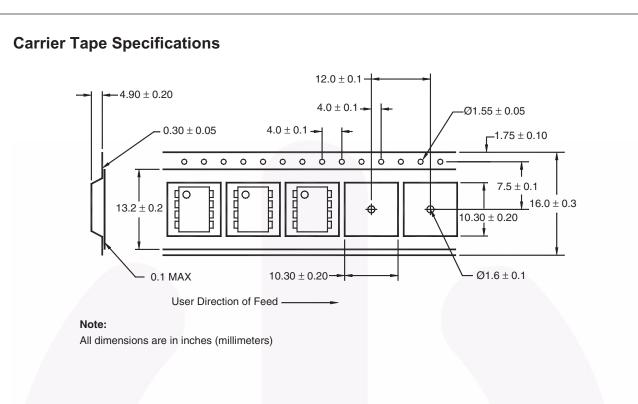
Ordering Information

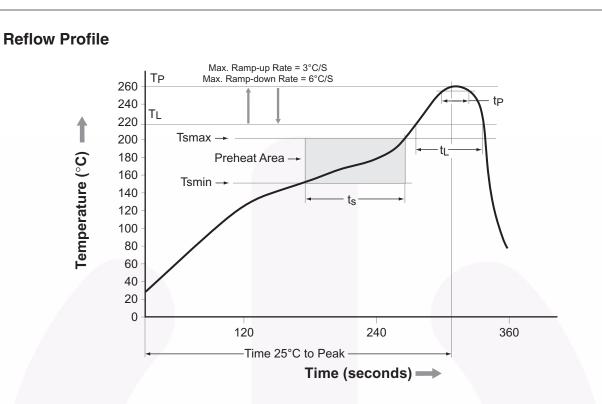
Option	Example Part Number	Description	
No Option	MTC9001	Standard Through Hole	
S	MTC9001S Surface Mount Lead Bend		
SD	MTC9001SD	Surface Mount; Tape and Reel	
300	MTC9001300	VDE Approved	
3S	MTC90013S	Surface Mount Lead Bend; VDE Approved	
3SD	MTC90013SD	Surface Mount; Tape and Reel; VDE Approved	
300W	MTC9001300W	0.4" Lead Spacing; VDE Approved	

Marking Information



Definitions				
1	Fairchild logo			
2	Device number			
3	VDE mark (Note: Only appears on parts ordered with VDE option – See order entry table)			
4	Two digit year code, e.g., '03'			
5	Two digit work week ranging from '01' to '53'			
6	Assembly package code			





Profile Feature	Pb-Free Assembly Profile		
Temperature Min. (Tsmin)	150°C		
Temperature Max. (Tsmax)	200°C		
Time (t _S) from (Tsmin to Tsmax)	60–120 seconds		
Ramp-up Rate (t _L to t _P)	3°C/second max.		
Liquidous Temperature (T _L)	217°C		
Time (t _L) Maintained Above (T _L)	60–150 seconds		
Peak Body Package Temperature	260°C +0°C / -5°C		
Time (t _P) within 5°C of 260°C	30 seconds		
Ramp-down Rate (T _P to T _L)	6°C/second max.		
Time 25°C to Peak Temperature	8 minutes max.		



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Datasheet Identification	Product Status	Definition			
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Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.			
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